What is claimed is:

- A composition for removing residues from the microstructure of an object comprising: carbon dioxide;
 an additive for removing the residues comprising a fluoride having a formula
 NR₁R₂R₃R₄F, where R₁, R₂, R₃, and R₄ are each independently a hydrogen or an alkyl group; and
 a co-solvent for dissolving said additive in said CO₂ at a pressurized fluid condition.
- 2. The composition of claim 1 wherein the additive further comprises a basic compound.
- 3. The composition of claim 1 wherein R_1 , R_2 , R_3 , and R_4 are hydrogen.
- 4. The composition of claim 1 wherein R_1 , R_2 , R_3 , and R_4 are an alkyl group.
- A composition for removing residues from the microstructure of an object comprising: carbon dioxide,
 a compound having a hydroxyl group,
 a fluoride having a formula NR₁R₂R₃R₄F, where R₁, R₂, R₃, and R₄ are each independently a hydrogen or an alkyl group.
- 6. The composition of claim 5 further comprising a basic compound.
- 7. The composition of claim 6 wherein the basic compound is selected from a quatenaryammoniumhydroxide, an alkylamine, an alkanolamine, a hydroxylamine, and mixtures thereof.
- 8. The composition of claim 5 further comprising a co-solvent selected from dimethylacetamide, propylene glycol, dimethylsulfoxide, deionized water, acetic acid, and mixtures thereof.

- 9. The composition of claim 8 wherein the co-solvent comprises deionized water.
- 10. The composition of claim 8 wherein the co-solvent is substantially free of water.
- 11. The composition of claim 5 wherein R_1 , R_2 , R_3 , and R_4 are hydrogen.
- 12. The composition of claim 5 wherein R₁, R₂, R₃, and R₄, are an alkyl group.
- 13. The composition of claim 5 wherein the fluoride is selected from ammonium fluoride, tetramethylammoniumfluoride, tetraethylammoniumfluoride, tetrabutylammoniumfluoride, tetrapropylammoniumfluoride, choline fluoride, and mixtures thereof.
- 14. The composition of claim 5 wherein the compound is selected from ethanol, methanol, n-propanol, isopropanol, n-butanol, iso-butanol, diethyleneglycolmonomethylether, diethyleneglycolmonoethylether, hexafluoroisopropanol, and mixtures thereof.
- 15. A composition for removing residues from the microstructure of an object comprising: carbon dioxide wherein the carbon dioxide is in a pressurized or a supercritical fluid state; an additive selected from a basic compound, a fluoride having a formula NR₁R₂R₃R₄F, where R₁, R₂, R₃, and R₄ are each independently a hydrogen or an alkyl group, and mixtures thereof; a cosolvent selected from an alcohol, dimethylacetamide, propylene glycol, dimethylsulfoxide, deionized water, acetic acid, and mixtures thereof.
- 16. The composition of claim 15 wherein the additive is dissolved within the cosolvent.
- 17. A composition for removing residues from the microstructure of an object comprising:

from 0.001 to 8 weight percent of an additive selected from a basic compound, a fluoride having a formula $NR_1R_2R_3R_4F$, where R_1 , R_2 , R_3 , and R_4 are each independently a hydrogen or an alkyl group, and mixtures thereof;

from 1 to 50 weight percent of a cosolvent selected from an alcohol, dimethylacetamide, propylene glycol, dimethylsulfoxide, deionized water, acetic acid, and mixtures thereof; and

carbon dioxide.

18. The composition of claim 17 wherein the residues are at least one selected from photoresist, UV-hardened resist, X-ray hardened resist, ashed resists, carbon-fluorine containing polymer, plasma etch residues, organic process contaminants, and inorganic process contaminants.